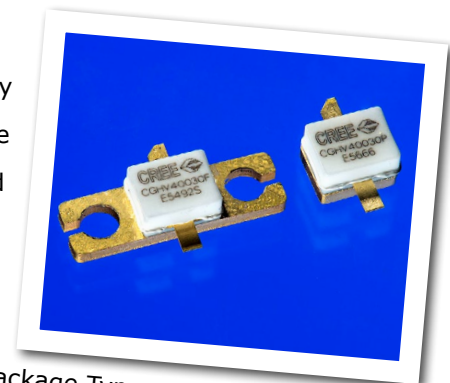


# CGHV40030

## 30 W, DC - 6 GHz, 50V, GaN HEMT

Cree's CGHV40030 is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities. The device can be deployed for L, S and C-Band amplifier applications. The datasheet specifications are based on a 0.96 - 1.4 GHz amplifier. The CGHV40030 operates on a 50 volt rail circuit while housed in a 2-lead flange or pill package.



Package Type: 440166 and 440196  
PN: CGHV40030

### Typical Performance 0.96 - 1.4 GHz ( $T_c = 25^\circ\text{C}$ ), 50 V

Parameter	0.96 GHz	1.1 GHz	1.25 GHz	1.4 GHz	Units
Gain @ $P_{SAT}$	15.6	15.8	16.6	15.8	dB
Saturated Output Power	29	30	36	31	W
Drain Efficiency @ $P_{SAT}$	62	74	64	67	%

Note:  
Measured CW in the CGHV40030-TB1 application circuit.

### Features

- Up to 6 GHz Operation
- 30 W Typical Output Power
- 16 dB Gain at 1.2 GHz
- Application circuit for 0.96 - 1.4 GHz
- 70% Efficiency at  $P_{SAT}$
- 50 V Operation

## Absolute Maximum Ratings (not simultaneous) at 25 °C Case Temperature

Parameter	Symbol	Rating	Units	Notes
Drain-Source Voltage	$V_{DSS}$	125	Volts	25 °C
Gate-to-Source Voltage	$V_{GS}$	-10, +2	Volts	25 °C
Storage Temperature	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature	$T_J$	225	°C	
Maximum Forward Gate Current	$I_{GMAX}$	5.2	mA	25 °C
Maximum Drain Current <sup>1</sup>	$I_{DMAX}$	4.2	A	25 °C
Soldering Temperature <sup>2</sup>	$T_S$	245	°C	
Case Operating Temperature <sup>3,4</sup>	$T_C$	-40, +150	°C	
Thermal Resistance, Junction to Case <sup>5</sup>	$R_{JJC}$	5.9	°C/W	85 °C

Note:

<sup>1</sup> Current limit for long term, reliable operation

<sup>2</sup> Refer to the Application Note on soldering at [www.cree.com/rf/document-library](http://www.cree.com/rf/document-library)

<sup>3</sup> Simulated at  $P_{DISS} = 23.4$  W

<sup>4</sup>  $T_C$  = Case temperature for the device. It refers to the temperature at the ground tab underneath the package. The PCB will add additional thermal resistance.

<sup>5</sup> CW

## Electrical Characteristics ( $T_C = 25$ °C) - 50 V Typical

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics<sup>1</sup></b>						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	$V_{DC}$	$V_{DS} = 10$ V, $I_D = 5.2$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.6	-	$V_{DC}$	$V_{DS} = 50$ V, $I_D = 150$ mA
Saturated Drain Current <sup>2</sup>	$I_{DS}$	4.2	5.2	-	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	100	-	-	$V_{DC}$	$V_{GS} = -8$ V, $I_D = 5.2$ mA
<b>RF Characteristics<sup>3</sup> (<math>T_C = 25</math> °C, <math>F_0 = 1.2</math> GHz unless otherwise noted)</b>						
Power Gain	$G_p$	-	16	-	dB	$V_{DD} = 50$ V, $I_{DQ} = 150$ mA, $P_{OUT} = P_{SAT}$
Output Power <sup>4</sup>	$P_{OUT}$	-	30	-	W	$V_{DD} = 50$ V, $I_{DQ} = 150$ mA, $P_{OUT} = P_{SAT}$
Drain Efficiency <sup>4</sup>	$\eta$	-	65	-	%	$V_{DD} = 50$ V, $I_{DQ} = 150$ mA, $P_{OUT} = P_{SAT}$
Output Mismatch Stress <sup>4</sup>	VSWR	-	-	10 : 1	$\Psi$	No damage at all phase angles, $V_{DD} = 50$ V, $I_{DQ} = 150$ mA, $P_{OUT} = 30$ W CW
<b>Dynamic Characteristics</b>						
Input Capacitance <sup>5</sup>	$C_{GS}$	-	7.4	-	pF	$V_{DS} = 50$ V, $V_{gs} = -8$ V, $f = 1$ MHz
Output Capacitance <sup>5</sup>	$C_{DS}$	-	2	-	pF	$V_{DS} = 50$ V, $V_{gs} = -8$ V, $f = 1$ MHz
Feedback Capacitance	$C_{GD}$	-	0.15	-	pF	$V_{DS} = 50$ V, $V_{gs} = -8$ V, $f = 1$ MHz

Notes:

<sup>1</sup> Measured on wafer prior to packaging

<sup>2</sup> Scaled from PCM data

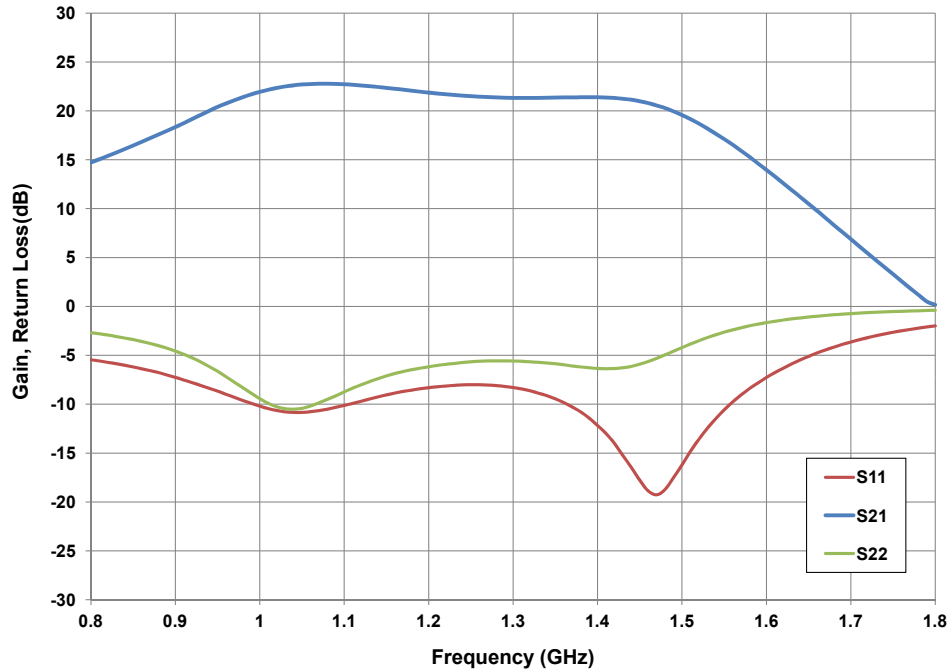
<sup>3</sup> Measured in CGHV40030-TB

<sup>4</sup>  $P_{SAT}$  is defined as  $I_G = 0.52$  mA

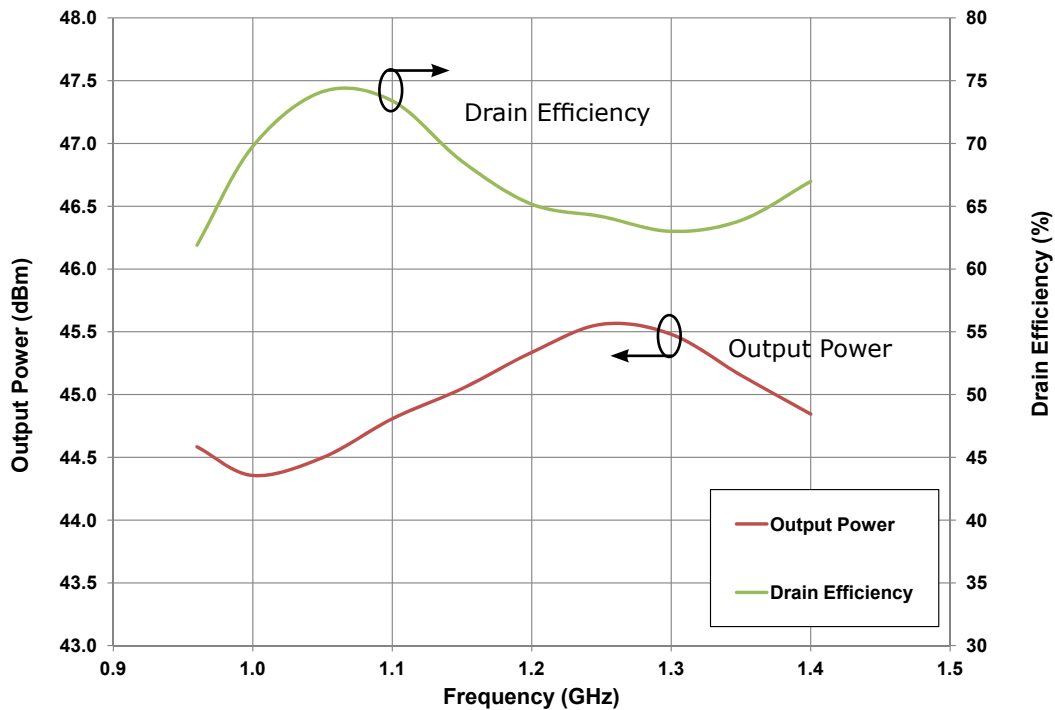
<sup>5</sup> Includes package

## Typical Performance

**Figure 1. - Typical Small Signal Response of CGHV40030-TB1 Application Circuit**  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 150\text{ mA}$



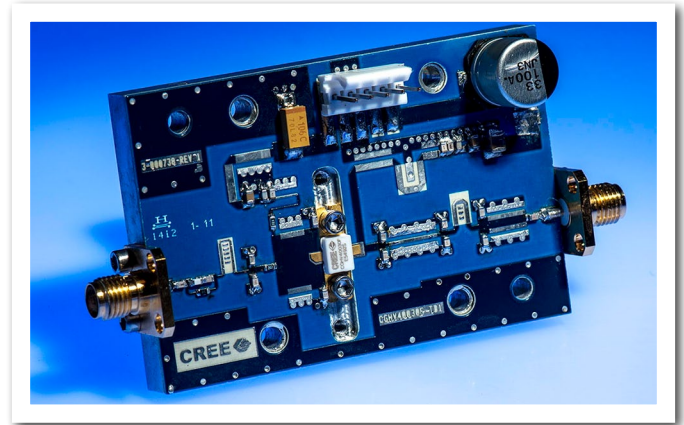
**Figure 2. - Typical Large Signal Response of CGHV40030-TB1 Application Circuit**  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 150\text{ mA}$ ,  $P_{IN} = 29\text{ dBm}$ ,  $T_{CASE} = 25^\circ\text{C}$ , CW



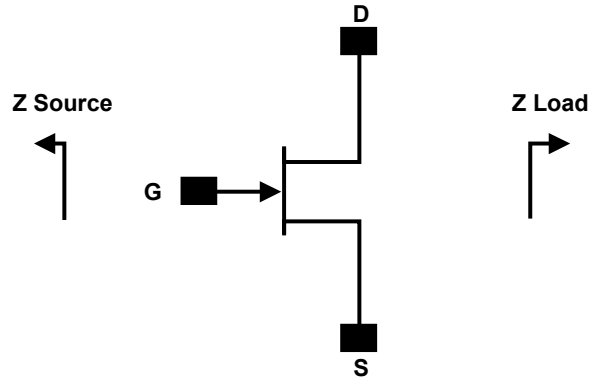
## CGHV40030-TB1 Application Circuit Bill of Materials

Designator	Description	Qty
R1	RES,1/16W,0603,1%,187 OHMS	1
R2	RES, 2.2 OHMS, +/- 1%, 1/16W,0603	1
R3	RES,1/16W,0603,1%,15.4 OHMS	1
L1	IND, 5.6nH, 0603	1
C3, C4	CAP, 2.7,+/-0.1pF, 0603, ATC	2
C5, C6, C11, C12	CAP, 1.2pF,+/-0.1pF, 0603, ATC	4
C2, C7, C8	CAP 1.8pF,+/-0.1pF 0603, ATC	2
C9, C10	CAP, 3.9pF,+/-0.1pF 0603, ATC	2
C1, C13	CAP, 24pF,+/-5% 0603, ATC	2
C14	CAP 10UF 16V TANTALUM	1
C15, C20	CAP, 33000pF, 0805, ATC	2
C16,C21	CAP, 470PF, 5%, 100V, 0603,	2
C17	CAP, 68pF,+/-0.1pF 0603, ATC	1
C22	CAP, 56PF +/- 5%, 0603 , ATC600S	1
C18	CAP, 33UF, 20%, G CASE	1
C19	CAP, 1.0UF, 100V, 10%, X7R, 1210	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST	2
J3	HEADER RT>PLZ .1CEN LK 5POS	1
	BASEPLATE, CGH35015, 2.60 X 1.7	1
	CGHV40030F/P PCB, RO4350, 0.020" THK	1

## CGHV40030-TB1 Application Circuit



## Source and Load Impedances



Frequency (MHz)	Z Source	Z Load
500	5.5 + j0.9	43 + j20.8
1000	2.6 - j1.3	25.5 + j29.1
2000	3.8 - j0.9	11.5 + j17.3
3000	2.7 - j7.0	6.7 + j7.8
4000	2.8 - j13.4	6.5 + j1.7

Note<sup>1</sup>:  $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 150\text{ mA}$

Note<sup>2</sup>: Impedances are extracted from source and load pull data derived from the transistor.

## Electrostatic Discharge (ESD) Classifications

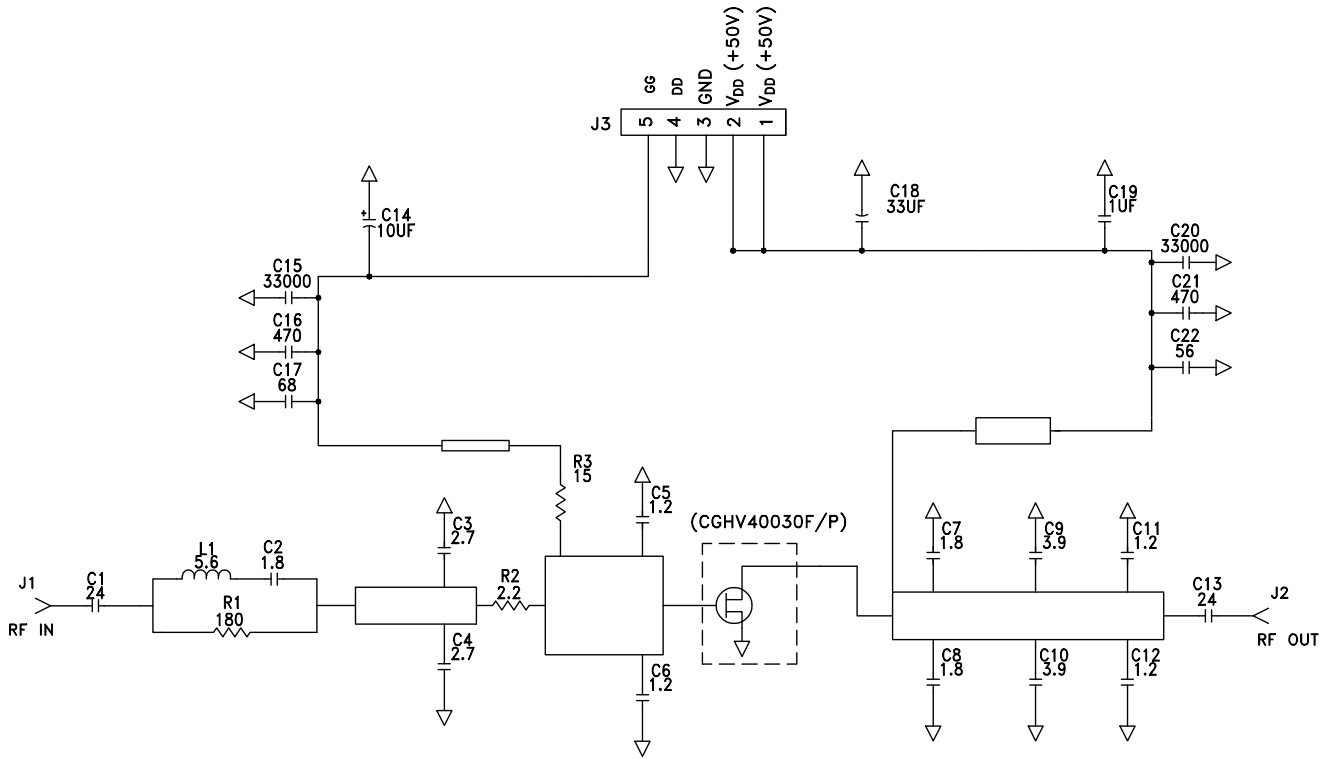
Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

## Typical Package S-Parameters for CGHV40030 (Small Signal, $V_{DS} = 50\text{ V}$ , $I_{DQ} = 0.52\text{ mA}$ , angle in degrees)

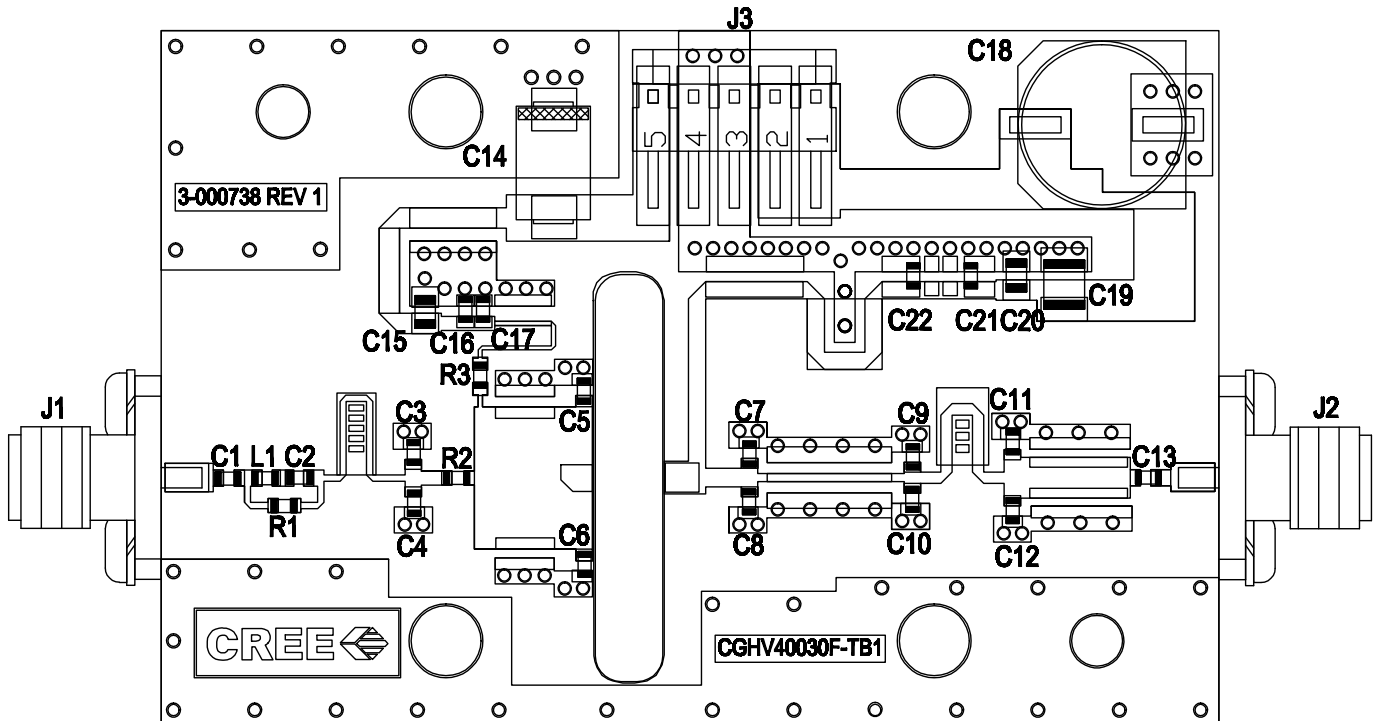
Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.92	-135.45	21.23	101.31	0.01	16.50	0.32	-74.10
600 MHz	0.92	-143.51	18.06	95.44	0.01	11.72	0.32	-79.66
700 MHz	0.91	-149.71	15.66	90.50	0.01	7.89	0.31	-84.44
800 MHz	0.91	-154.67	13.78	86.16	0.01	4.69	0.32	-88.69
900 MHz	0.91	-158.75	12.27	82.26	0.01	1.97	0.33	-92.58
1.0 GHz	0.91	-162.21	11.04	78.67	0.01	-0.41	0.34	-96.19
1.1 GHz	0.91	-165.20	10.02	75.32	0.01	-2.50	0.35	-99.57
1.2 GHz	0.91	-167.83	9.15	72.16	0.01	-4.34	0.36	-102.79
1.3 GHz	0.91	-170.19	8.41	69.14	0.01	-5.98	0.37	-105.86
1.4 GHz	0.92	-172.34	7.76	66.24	0.01	-7.43	0.39	-108.80
1.5 GHz	0.92	-174.30	7.20	63.45	0.01	-8.69	0.40	-111.64
1.6 GHz	0.92	-176.13	6.70	60.74	0.01	-9.77	0.42	-114.39
1.7 GHz	0.92	-177.83	6.26	58.11	0.01	-10.67	0.43	-117.06
1.8 GHz	0.92	-179.44	5.86	55.54	0.01	-11.39	0.45	-119.65
1.9 GHz	0.92	179.04	5.50	53.03	0.01	-11.90	0.46	-122.18
2.0 GHz	0.92	177.58	5.18	50.58	0.01	-12.20	0.48	-124.64
2.1 GHz	0.92	176.19	4.89	48.17	0.01	-12.26	0.49	-127.05
2.2 GHz	0.92	174.84	4.62	45.81	0.01	-12.07	0.51	-129.41
2.3 GHz	0.93	173.54	4.37	43.50	0.01	-11.60	0.52	-131.72
2.4 GHz	0.93	172.28	4.14	41.22	0.01	-10.82	0.53	-133.98
2.5 GHz	0.93	171.06	3.93	38.98	0.01	-9.70	0.55	-136.21
2.6 GHz	0.93	169.86	3.73	36.78	0.01	-8.20	0.56	-138.39
2.7 GHz	0.93	168.70	3.55	34.62	0.01	-6.30	0.57	-140.53
2.8 GHz	0.93	167.55	3.38	32.49	0.01	-3.97	0.59	-142.63
2.9 GHz	0.93	166.43	3.23	30.39	0.01	-1.18	0.60	-144.70
3.0 GHz	0.94	165.33	3.08	28.33	0.01	2.04	0.61	-146.73
3.2 GHz	0.94	163.18	2.81	24.29	0.01	9.69	0.64	-150.70
3.4 GHz	0.94	161.08	2.57	20.36	0.01	18.36	0.66	-154.54
3.6 GHz	0.94	159.05	2.36	16.55	0.01	27.05	0.68	-158.26
3.8 GHz	0.95	157.05	2.17	12.85	0.01	34.79	0.70	-161.87
4.0 GHz	0.95	155.10	2.00	9.25	0.01	41.04	0.72	-165.37
4.2 GHz	0.95	153.19	1.85	5.75	0.01	45.73	0.73	-168.77
4.4 GHz	0.95	151.31	1.72	2.35	0.01	49.02	0.75	-172.07
4.6 GHz	0.96	149.46	1.59	-0.96	0.01	51.19	0.76	-175.28
4.8 GHz	0.96	147.65	1.48	-4.18	0.01	52.48	0.78	-178.39
5.0 GHz	0.96	145.86	1.37	-7.31	0.01	53.11	0.79	178.58
5.2 GHz	0.96	144.11	1.28	-10.36	0.01	53.24	0.80	175.63
5.4 GHz	0.96	142.38	1.19	-13.33	0.01	52.98	0.82	172.76
5.6 GHz	0.96	140.68	1.11	-16.22	0.02	52.43	0.83	169.97
5.8 GHz	0.97	139.00	1.04	-19.03	0.02	51.65	0.84	167.25
6.0 GHz	0.97	137.35	0.98	-21.76	0.02	50.70	0.85	164.60

To download the s-parameters in s2p format, go to the CGHV40030 Product Page and click on the documentation tab.

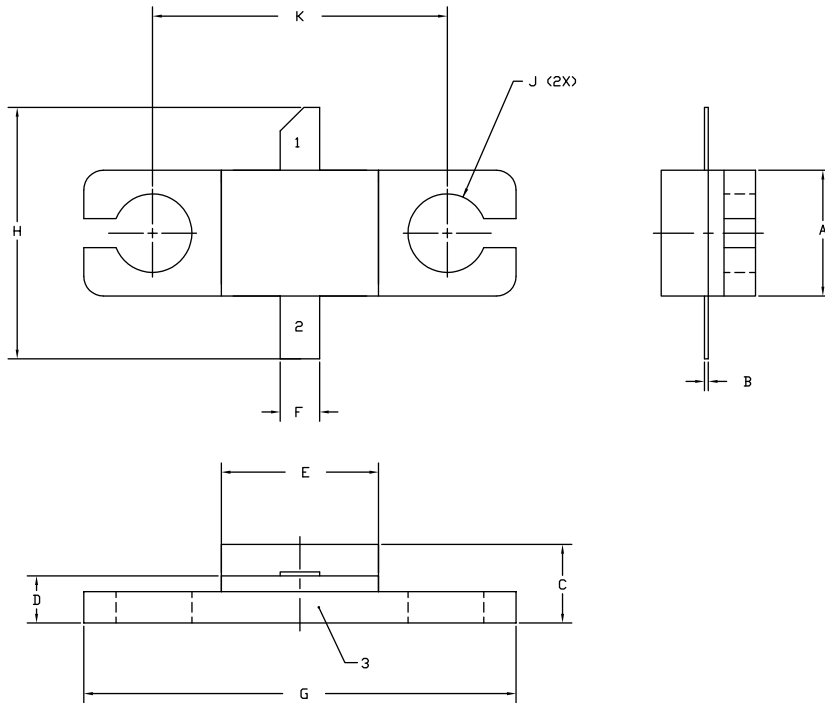
## CGHV40030-TB1 Application Circuit Schematic



## CGHV40030-TB1 Application Circuit Outline



## Product Dimensions CGHV40030F (Package Type - 440166 )



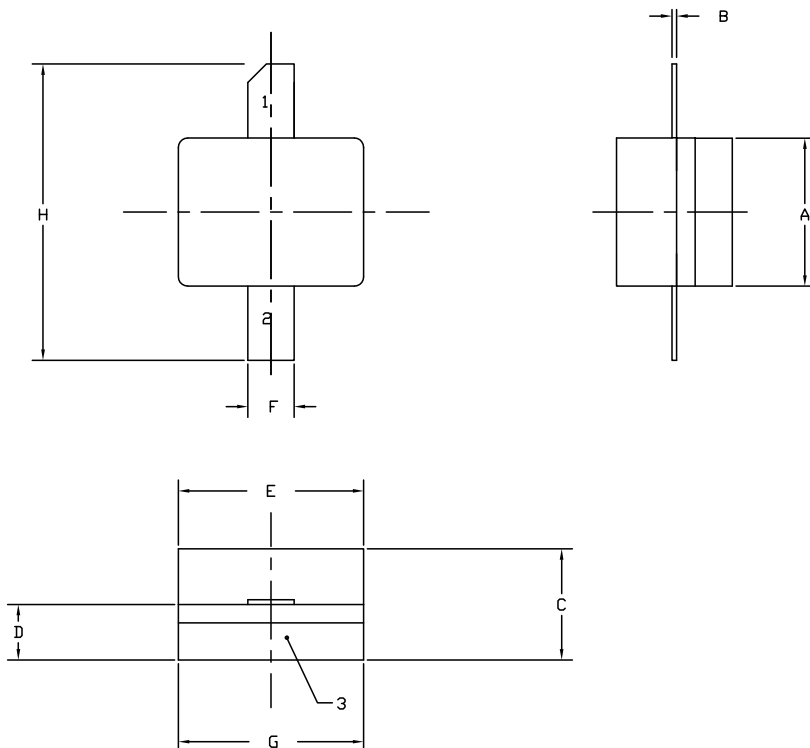
**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.004	0.006	0.10	0.15
C	0.115	0.135	2.92	3.43
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.545	0.555	13.84	14.09
H	0.280	0.360	7.11	9.14
J	Ø .100		2.54	
K	0.375		9.53	

PIN 1. GATE  
 PIN 2. DRAIN  
 PIN 3. SOURCE

## Product Dimensions CGHV40030P (Package Type - 440196)



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
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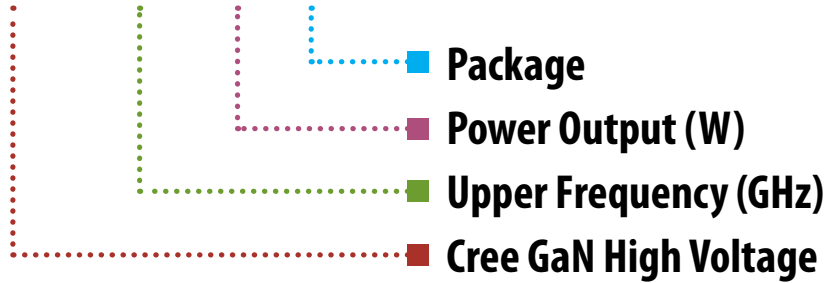
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.003	0.006	0.10	0.15
C	0.115	0.135	2.92	3.17
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.195	0.205	4.95	5.21
H	0.280	0.360	7.11	9.14

PIN 1. GATE  
 PIN 2. DRAIN  
 PIN 3. SOURCE



## Part Number System

### CGHV40030F/P



Parameter	Value	Units
Upper Frequency <sup>1</sup>	6	GHz
Power Output	30	W
Package	Flanged/Pill	-

**Table 1.**

**Note<sup>1</sup>:** Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

**Table 2.**

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«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

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